

STANDARDS

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ANSI/NECA/BICSI 607-2011

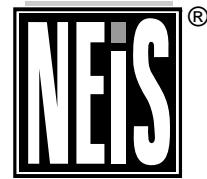
**Standard for
Telecommunications Bonding and Grounding
Planning and Installation Methods
for Commercial Buildings**



NECA/BICSI 607-2011

Standard for
**Telecommunications Bonding and
Grounding Planning and Installation
Methods for Commercial Buildings**

**An American
National Standard**



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